

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	51452	(bonding bond) near pad	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 09:43
L2	69901	(benzotriazole benzotriazole bta benzimidazole benzimidazole glicoat preventol)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 10:42
L3	287	2 with spray\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 09:49
L4	56	2 near3 spray\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 09:49
L5	1	(glicoat preventol) with (protecting protective protect protected)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 10:44
L6	419	shikoku near chemical	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 10:44
L7	1	6 with bta	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 10:47
L8	554	bayer near chemical	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 10:46

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L9	0	8 with bta	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 13:22
L10	8347	2 same(copper cu nickel ni gold au "ni/au" "cu/ni/au")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 13:22
L11	49	2 same ((copper cu) with (nickel ni) with (gold au))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 13:35
L12	2529	(pad ((conductive metal) near1 (layer wire wiring pattern trace))) with ((copper cu) near3 (nickel ni) near3 (gold au))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 13:37
L13	865	(pad ((conductive metal) near1 (layer wire wiring pattern trace))) near3 ((copper cu) near3 (nickel ni) near3 (gold au))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 13:42
L14	651	13 with layer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 13:38
L15	828	(pad ((conductive metal) near1 (layer pattern trace))) near3 ((copper cu) near3 (nickel ni) near3 (gold au))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 13:38
L16	644	15 with layer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 13:38

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L17	8	16 with ((three "3") near layers)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 13:42
L18	2529	(pad ((conductive metal) near1 (layer wire wiring pattern trace))) with ((copper cu) near3 (nickel ni) near3 (gold au))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 14:11
L19	18	18 with (three near layers)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 13:42
L20	68	(three near layers) with ((copper cu) near3 (nickel ni) near3 (gold au))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 14:12
L21	0	20 with (conventional known common)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 14:12
L22	32	20 same (pad wiring pattern trace)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/13 14:13